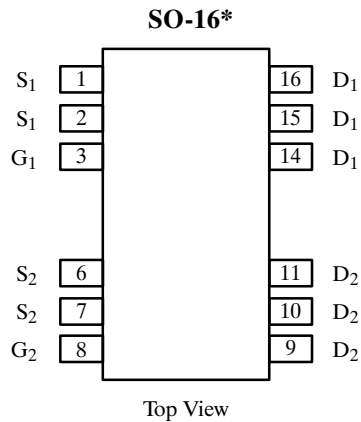


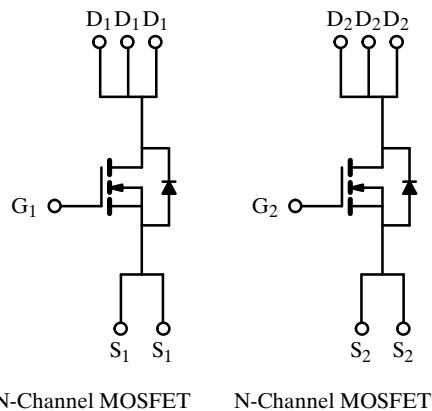
Dual N-Channel Enhancement-Mode MOSFET

Product Summary

| V_{DS} (V) | $r_{DS(on)}$ (Ω) | I_D (A) |
|--------------|---------------------------|-----------|
| 50 | 0.05 @ $V_{GS} = 10$ V | ± 5.3 |
| | 0.07 @ $V_{GS} = 4.5$ V | ± 4.5 |



*Conforms to standard SO-16 dimensions



Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

| Parameter | Symbol | Limit | Unit |
|---|----------------|--------------------------|------------------|
| Drain-Source Voltage | V_{DS} | 50 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | |
| Continuous Drain Current ($T_J = 150^\circ\text{C}$) ^a | I_D | $T_A = 25^\circ\text{C}$ | ± 5.3 |
| | | $T_A = 70^\circ\text{C}$ | ± 4.2 |
| Pulsed Drain Current | I_{DM} | ± 20 | A |
| Continuous Source Current (Diode Conduction) ^a | I_S | 2.5 | |
| Maximum Power Dissipation ^a | P_D | $T_A = 25^\circ\text{C}$ | 2.5 |
| | | $T_A = 70^\circ\text{C}$ | 1.6 |
| Operating Junction and Storage Temperature Range | T_J, T_{stg} | -55 to 150 | $^\circ\text{C}$ |

Thermal Resistance Ratings

| Parameter | Symbol | Limit | Unit |
|--|------------|-------|---------------------------|
| Maximum Junction-to-Ambient ^a | R_{thJA} | 50 | $^\circ\text{C}/\text{W}$ |

Notes

a. Surface Mounted on FR4 Board, $t \leq 10$ sec.

Subsequent updates to this data sheet may be obtained via facsimile by calling Siliconix FaxBack, 1-408-970-5600. Please request FaxBack document #1211.

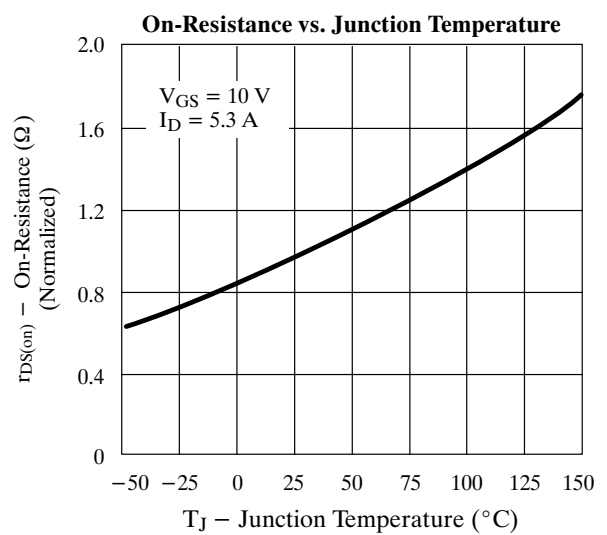
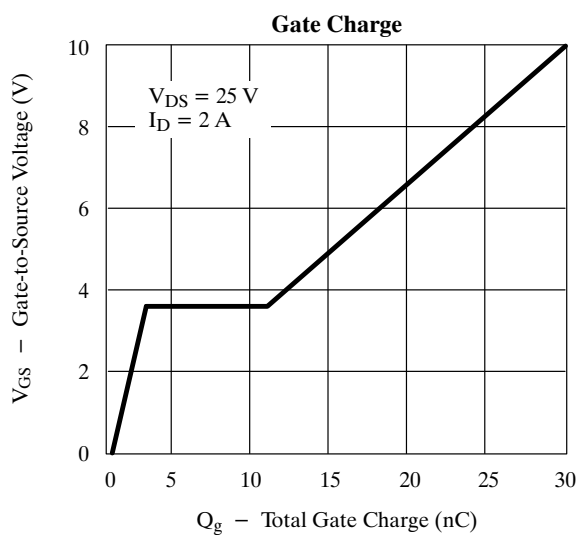
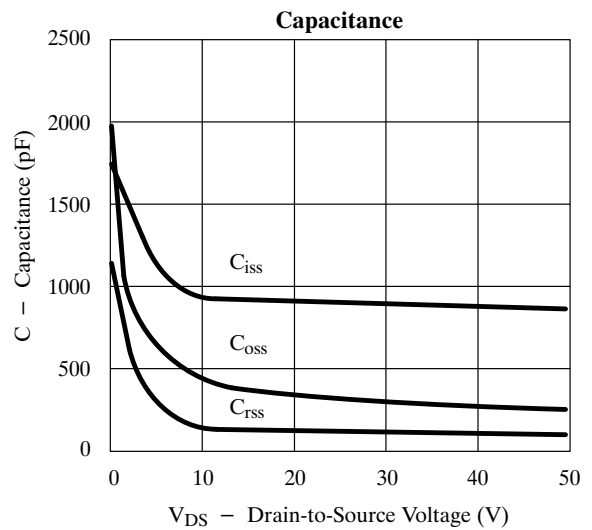
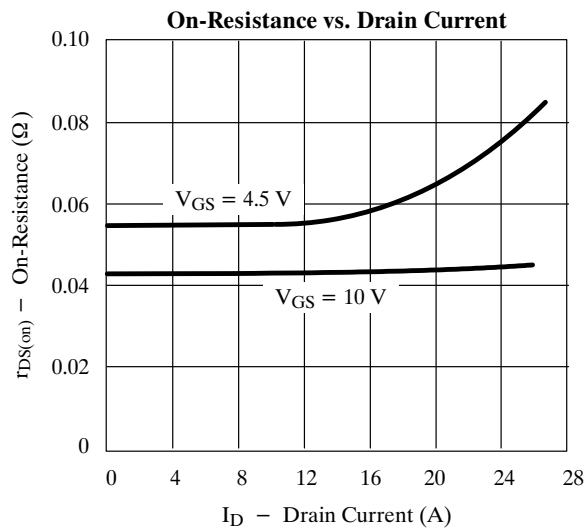
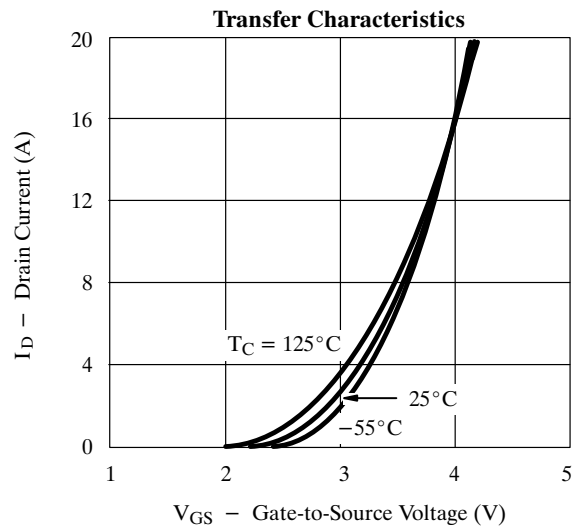
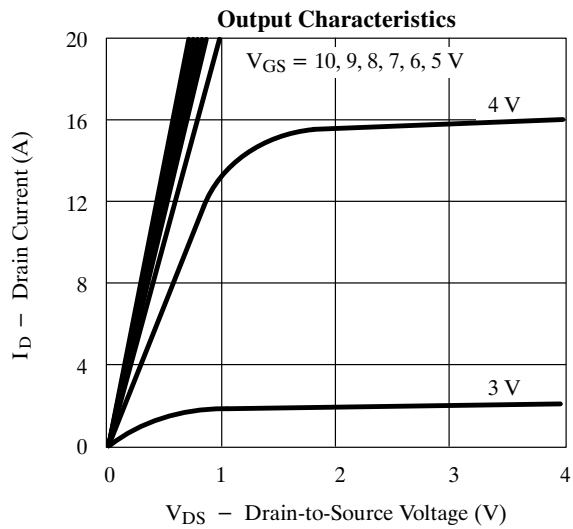
Specifications ($T_J = 25^\circ\text{C}$ Unless Otherwise Noted)

| Parameter | Symbol | Test Condition | Min | Typ ^a | Max | Unit |
|---|--------------|---|-----|------------------|-----------|---------------|
| Static | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$ | 1.0 | | | V |
| Gate-Body Leakage | I_{GSS} | $V_{DS} = 0\ \text{V}, V_{GS} = \pm 20\ \text{V}$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 40\ \text{V}, V_{GS} = 0\ \text{V}$ | | | 2 | μA |
| | | $V_{DS} = 40\ \text{V}, V_{GS} = 0\ \text{V}, T_J = 55^\circ\text{C}$ | | | 25 | |
| On-State Drain Current ^b | $I_{D(on)}$ | $V_{DS} \geq 5\ \text{V}, V_{GS} = 10\ \text{V}$ | 20 | | | A |
| Drain-Source On-State Resistance ^b | $r_{DS(on)}$ | $V_{GS} = 10\ \text{V}, I_D = 5.3\ \text{A}$ | | 0.042 | 0.05 | Ω |
| | | $V_{GS} = 4.5\ \text{V}, I_D = 4.5\ \text{A}$ | | 0.055 | 0.07 | |
| Forward Transconductance ^b | g_{fs} | $V_{DS} = 15\ \text{V}, I_D = 5.3\ \text{A}$ | | 11 | | S |
| Diode Forward Voltage ^b | V_{SD} | $I_S = 1.5\ \text{A}, V_{GS} = 0\ \text{V}$ | | 0.8 | 1.2 | V |
| Dynamic^a | | | | | | |
| Total Gate Charge | Q_g | $V_{DS} = 25\ \text{V}, V_{GS} = 10\ \text{V}, I_D = 2\ \text{A}$ | | 30 | 50 | nC |
| Gate-Source Charge | Q_{gs} | | | 2.5 | | |
| Gate-Drain Charge | Q_{gd} | | | 9.4 | | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD} = 25\ \text{V}, R_L = 25\ \Omega$ $I_D \cong 1\ \text{A}, V_{GEN} = 10\ \text{V}, R_G = 6\ \Omega$ | | 17 | 40 | ns |
| Rise Time | t_r | | | 30 | 60 | |
| Turn-Off Delay Time | $t_{d(off)}$ | | | 95 | 150 | |
| Fall Time | t_f | | | 55 | 100 | |
| Source-Drain Reverse Recovery Time | t_{rr} | $I_F = 1.5\ \text{A}, di/dt = 100\ \text{A}/\mu\text{s}$ | | 130 | | |

Notes

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.

Typical Characteristics (25°C Unless Otherwise Noted)



Si9940DY

Typical Characteristics (25°C Unless Otherwise Noted)

